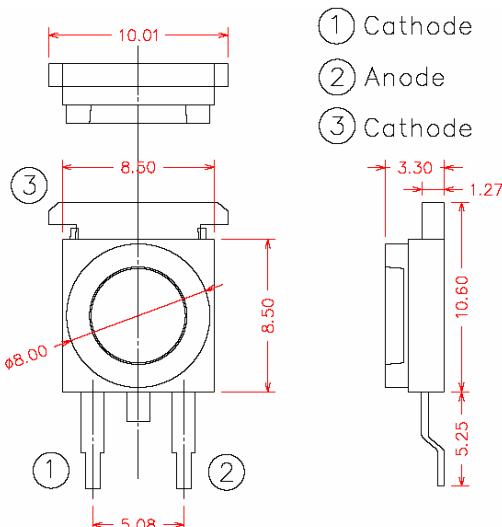


Color	Type	Technology	Case
Red	RH-625-T110-350	AllnGaP/GaP	TO220, short pins



Maximum Ratings at $T_a = 25^\circ\text{C}$

Parameter	Test conditions	Symbol	Value	Unit
Forward current		I_F	350	mA
Peak forward current	Duty 1/100, $f \leq 1 \text{ kHz}$	I_{FP}	400	mA
Power dissipation		P_D	1.1	W
Reverse voltage	$I_R=10 \mu\text{A}$	V_R	5	V
Reverse current	$U_R=5 \text{ V}$	I_R	50	μA
Operating temperature		T_{opr}	-20 to +70	$^\circ\text{C}$
Storage temperature		T_{stg}	-40 to +85	$^\circ\text{C}$
Soldering temperature	5 sec max, 2 mm from body	T_{sol}	260	$^\circ\text{C}$

Electrical and Optical Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Test conditions	Symbol	Min.	Typ.	Max.	Unit
Forward voltage	$I_F = 350 \text{ mA}$	V_F	-	2.1	3.2	V
Luminous flux	$I_F = 350 \text{ mA}$	Φ_V	12	22	-	lm
Peak wavelength	$I_F = 350 \text{ mA}$	λ_p	-	625	-	nm
Dominant wavelength	$I_F = 350 \text{ mA}$	λ_d	-	625	-	nm
Spectral halfwidth	$I_F = 350 \text{ mA}$	$\Delta\lambda$	-	30	-	nm
Viewing angle	$I_F = 350 \text{ mA}$	ϕ	-	110	-	deg.
Thermal resistance junction to board	$I_F = 350 \text{ mA}$	$R\theta_{J-B}$	-	22	-	K/W